



Film Control General Parameters


Available films


☒  BOTTOM


- ☒ VIA CLASS/BOTTOM
- ☒ PIN/BOTTOM
- ☒ ETCH/BOTTOM
- ☒ BOARD GEOMETRY/OUTLINE

☒  BOTTOMSILK


- ☒ BOARD GEOMETRY/OUTLINE
- ☒ PACKAGE GEOMETRY/SILKSCREEN
- ☒ REF DES/SILKSCREEN\_BOTTOM


☒  BOTTOMSOLDER


☒  BOTTOM\_PASTE


☒  LAYER2

- ☒ VIA CLASS/LAYER2
- ☒ PIN/LAYER2
- ☒ ETCH/LAYER2
- ☒ BOARD GEOMETRY/OUTLINE

☒  LAYER3

☒  LAYER4

☒  LAYER5

☒  LAYER6

Select all

Add...

Replace...

☒ Check database before artwork

Create Artwork

Film options

Film name: drill

Rotation: 0

Offset X: 0.0000

Y: 0.0000

Undefined line width: 0.1200

Shape bounding box: 2.5400

Plot mode: ☒ Positive  
☐ Negative

☐ Film mirrored

☐ Full contact thermal-reliefs

☒ Suppress unconnected pads

☐ Draw missing pad apertures

☐ Use aperture rotation

☐ Suppress shape fill

☒ Vector based pad behavior

OK

Cancel

Apertures...

Viewlog...

Help